# टाटा मूलभूत अनुसंधान संस्थान हैदराबाद / TATA INSTITUTE OF FUNDAMENTAL RESEARCH HYDERABAD

प्लाट नं. ३६/पी, गोपनपल्ली ग्राम, सेरिलिंगमपल्ली मंडल, रंगा रेड्डी जिला, हैदराबाद – ५०० १०७, तेलंगाना.

Plot No.36/P, Gopanpally Village, Serilingampally Mandal, Ranga Reddy District, Hyderabad - 500 107, Telangana, India.

टेलीफोन /Telephone: +91-40-2020 3020 ई-मेल /Email: purchasegroup@tifrh.res.in वेबसाइट /Website: www.tifrh.res.in तिथि /Date: 16-05-2024

निम्नलिखित मदों के लए एनआईटी व निविदा प्रपत्र (दो भाग पब्लिक टेंडर) / Notice Inviting Tender cum Tender Document (Two Part Public Tender) for the following items:

# Supply, Installation and Commissioning of High-Performance Computing (HPC) Cluster for TIFR Hyderabad.

As per technical specifications in Annexure A.

| निविदा संख्या / Tender No.                     | TIFR/PD/CA24-02/24-25/M/02  |
|--|---|
| प्रकाशन की तिथि / Date of Publishing           | 16-05-2024  |
| प्री-बिड मीटिंग की तिथि / Pre-Bid Meeting Date | 22-05-2024 at 11.00 Hrs.  |
|  | (Through ZOOM- Zoom link details please visit   |
|  | our website <a href="https://www.tifrh.res.in/tender/">https://www.tifrh.res.in/tender/</a> |
|  | / Direct Visit at TIFR, Hyderabad premises)   |
| निविदा शुल्क / Tender Fees                     | Rs. 00 (USD 00)   |
|  |   |
| ईएमडी / EMD                                    |   |
| (Earnest Money Deposit)                        | Rs.15,00,000.00   |
| अनुमानित मूल्य / Estimated Cost                | Rs. 7,50,00,000.00  |
| (Estimated cost up to TIFR, Hyderabad          |   |
| premises inclusive of all applicable charges,  |   |
| taxes, duties etc.)                            |   |
| चेनी नाम करने की अंग्रिम गिल                   | 02.07.2024 unto 12.00 Hrs   |
| बोली जमा करने की अंतिम तिथि                    | 03-07-2024 upto 13.00 Hrs.  |
| / Last Date for Submission of Bid              | 22.25.2224 . 45.224   |
| बोलियों के प्रारंभ होने की तिथि (भाग ए)        | 03-07-2024 at 15.00 Hrs.  |
| / Date of Opening Bids (Part A)                |   |

निविदा को बंद लिफाफे में जामा करना जरूरी है। लिफाफे के ऊपर निविदा संख्या नियत तिथि का उल्लेख स्पष्ट रूप से होना चाहिए / Tender should be submitted in sealed enveloped super scribed with the Tender No., Due Date in Bold Letters.

अवधक विवरणों, विनिर्देश, शर्तें आदि के लिए कृपया हमारी वेबसाइट देखे: I For more information, specifications, terms and conditions etc., please visit our website:

https://www.tifrh.res.in/tender/

प्री-बिड मीटिंग ऑनलाइन के माध्यम से आयोजित की जाएगी। बिडरों से अनुरोध है कि वे टीआईएफआर हैदराबाद वेबसाइट निविदा पृष्ठ को प्री-बिड मीटिंग जूम लिंक के लिए देखें। बिडर प्री-बिड मीटिंग टीआईएफआर हैदराबाद परिसर में भी निर्धारित तिथि और समय पर शामिल हो सकते हैं।/ Pre- Bid meeting will be conducted through online. Bidders are requested to refer TIFR Hyderabad website tender page for pre-bid meeting zoom link. Bidder may also join the meeting on scheduled date and time at TIFR, Hyderabad premises.

प्रशासवनक अवधकारी / ADMINISTRATIVE OFFICER (क्रय अनुभाग) / (PURCHASE SECTION) टीआईएफआर हैदराबाद / TIFR HYDERABAD

#### Annexure - A

# Technical Specifications for Supply, Installation and Commissioning of High-Performance Computing (HPC) Cluster for TIFR Hyderabad Technical pre-qualification for the bidders

Mandatory requirements for a bidder to qualify as a participant in this tender:

| s.no | Technical pre-qualification criteria   | Compliance<br>Yes/No | Remarks |
|------|--|----------------------|---------|
| 1.   | The bidders should have minimum three successful installations at Government/ Public/ Private Research organizations /institutions /Manufacturing industries using architecture and technologies to those being proposed in their quotation against this tender across the country within the last five years.   |                      |         |
|      | <ul> <li>In addition, the following condition should also be satisfied.</li> <li>At least one installation of minimum 80% or</li> <li>At least two installations of each 60% or</li> <li>At least three installations of each 40% of the tender value Purchase order with final commissioning report with the mention of compute architecture details duly signed by customer should be submitted with the technical bid. The contact details of the customer's technical person should be provided. TIFR-H may independently contact them to verify the claim.</li> </ul> |                      |         |
| 2.   | The Bidder/OEM should have minimum three entries in the latest top supercomputer India list maintained by CDAC, India (which can be downloaded from <a href="http://topsc.cdacb.in/">http://topsc.cdacb.in/</a> )  |                      |         |
| 3.   | All warranty and support must be serviced directly by the OEM or should be from an authorized System Integrator Partner who is authorized to Support the product quoted. TIFR-H requires that there be a Single Point of Contact (SPOC) from OEM and bidder who is responsible for all issues between TIFR-H and the OEM.  |                      |         |
| 4.   | Bidder should be either an Original Equipment Manufacturer (OEM) or should be authorized System Integrator Partner having back to back Support Agreement with the OEM. Manufacturer's Authorization Form (MAF) for participating in this tender is mandatory for bidders and should be attached along with technical bid. The Bidder participating in the tender process should give the MAF confirming the bidder's authorization to participate in the tender with tender number and details.  |                      |         |

| 5.  | The bidder should provide direct access to OEM's support portal for raising tickets related to hardware/software support or RMA. If the bidder fails to respond within the stipulated time for any open tickets, TIFR-H reserves the right to contact OEM and raise tickets directly to resolve the issue. Along with the MAF, OEM should confirm the same in their letter head and submitted along with the technical bid. |  |
|-----|---|--|
| 6.  | The Bidder/OEM should have a service center with L1/L2 engineers stationed at Hyderabad in the relevant field of quoted item. Documentary proofs for the same should be enclosed.   |  |
| 7.  | Hardware and software warranty support requests to be handled and serviced directly by OEM/Bidder. OEM/Bidder should have required critical spares at local service center.   |  |
| 8.  | The complete proposed solution must have all encompassing comprehensive onsite warranty of 5 years duration which includes hardware, software, firmware, software updates, etc., If the hardware replacement process takes more than two days, the bidder/OEM should provide a standby hardware till the replacement is made.   |  |
| 9.  | The OEM/Bidder must have an India based support infrastructure by maintaining a local spares depot in the country. This is to ensure immediate delivery of spare parts from OEM to its channel partner/system integrator.   |  |
| 10. | Products offered should have official OEM support for next five years from the date of acceptance of installation.  |  |
| 11. | All quotations submitted must follow the prescribed format for technical compliance as in the document below. Failure to do will result in the quotation being summarily rejected. Soft copy of the technical bid document in excel format should also be submitted.  |  |
| 12. | One bidder can propose only one technical solution and the price<br>bid for the same should be submitted. Quoting multiple technical<br>solutions with multiple price bids will result in the quotation being<br>summarily rejected.  |  |
| 13. | The complete hardware should be factory integrated and tested at the OEM factory. Any alteration in a configuration outside the OEM factory is not allowed.   |  |

#### TECHNICAL QUALIFYING CRITERIA

#### a) High Performance Computing Cluster

The OEM/bidder should carry out below listed benchmark programs on 10 TF, 30 TF and 50 TF peak performance configurations of the proposed solution and also produce the extrapolated outputs of the 100 TF, 200 TF and fully offered solution in peak performance configurations. It is not necessary to run the benchmark codes on the same quoted processor mentioned in the tender. However, the produced results should match with the results of the offered solution as a part of the acceptance test. The maximum allowable deviation from the extrapolated results in the acceptance test should be less than 3%. The results (with TFLOP and core count where applicable) should be presented in an output file and included in the technical bid.

- High Performance Linpack (HPL) Benchmark should be provided for the above mentioned configurations and the same will be considered for technical evaluation. The minimum required performance for technical qualification is 80%.
- Other applications for Benchmark LAMMPS, P3DFFT, GROMACS. (https://www.tifrh.res.in/webdata/documents/events/tenders/2024/mar/bm2024.zip)

Note: All the above benchmark codes including HPL should be run using open source gnu compilers 9.0 or above, openmpi 4.0 or above. Other commercial compilers or any code optimizations are not allowed for benchmarking.

Provide read-only output of the above benchmark on DVD/CD along with the bid. Do not provide the print out of the outputs. Proposals of vendors who do not fulfill the above criteria or who fail to submit documentary proof would be rejected.

#### b) Storage Solution

As a part of acceptance test, the bidder should run the following benchmarks on the offered storage solution and results of the same should be submitted.

Open source Bonie++ and IOR/IOZone benchmarks must be used to demonstrate aggregate performance of the storage system. They must be run with many to one distribution of large sequential read and write of 1MB I/O block size.

#### **Scope of Work**

#### Scope of work includes the following

Supply, Installation and Commissioning of a High Performance Computing Cluster (HPCC) as per the specifications below

#### Technical Specifications of the High Performance Computing cluster

#### **Mandatory Clause**

- 1. All warranty and support must be serviced directly by the OEM or should be from an authorized System Integrator Partner who is authorized to Support the product quoted. TIFR-H requires that there be a Single Point of Contact (SPOC) from OEM/Bidder who is responsible for all issues between TIFR-H and the OEM.
- 2. All the hardware and software deployment will be in vendor's scope of work and vendors need to install open source software required by the end user at the time of deployment.
- 3. The entire computer nodes must be factory integrated, tested, validated and certified in the bidder/OEM site. No on-site or local assembling of the system at TIFR-H site is allowed. Only rack-mounting, OS and application installation is allowed on-site.

#### **Mandatory items**

|      | Computer Hardware |     | •               | odel/Rema                |             |
|------|-------------------|-----|-----------------|--------------------------|-------------|
| S.No | Description       | Qty | Make &<br>Model | Complia<br>nce<br>Yes/No | Remar<br>ks |
| 1    | Login Node        | 1   |                 |                          |             |

Master node should have minimum 16 AMD EPYC 4th generation CPU Cores or higher with minimum base clock speed of 3.0 GHz or better. The processors Must have Native support of AVX 256 instructions or better. Along with CPU specifications, the node should have the following configurations or better

| CPU Details   |  |  |
|---|--|--|
| Memory Details – 384 GB DDR5 ECC RAM in a fully balanced configuration with populating all DIMM slots to its fully available bandwidth. Memory speed – Maximum memory speed supported by the quoted CPUs. |  |  |
| 2 x 960 GB Enterprise 3 DWPD SAS SSD configured in RAID 1 with one hot spare  |  |  |
| Minimum 2 x 1 Gbps Ethernet ports to connect to TIFR-H LAN. Required accessories also to be quoted for connecting to the LAN.   |  |  |
| 2 x 10 G copper RJ 45 ports   |  |  |
| IPMI 2.0 or equivalent Support with KVM and Media over LAN features. Must include any licenses, if required for using these features  |  |  |

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|--------|---|--|--------------|------------|-----------|
|        | Form factor - 1U or better full width server form factor with sliding rack mount kit and peripherals  |  |              |            |           |
|        | 80 Plus platinum or better redundant power supply with IEC C13 to IEC C14 cables  |  |              |            |           |
|        | Compute connectivity as per Item no – 6   |  |              |            |           |
| 2      | Master Node   | 1  |              |            |           |
| base o | er node should have minimum 16 AMD EPYC 4th g<br>clock speed of 3.0 GHz or better. The processors Muster. Along with CPU specifications, the node should  | st have Native s   | support of A | VX 256 ins | tructions |
|        | CPU Details   |  |              |            |           |
|        | Memory Details – 384 GB DDR5 ECC RAM in a fully balanced configuration with populating all DIMM slots to its fully available bandwidth. Memory speed – Maximum memory speed supported by the quoted CPUs. |  |              |            |           |
|        | 2 x 960 GB Enterprise 3 DWPD SATA SSD configured in RAID 1 with one hot spare   |  |              |            |           |
|        | 2 x 1 G Ethernet Ports  |  |              |            |           |
|        | 2 x 10 G SFP+ Ports with SC-LC Multi mode modules   |  |              |            |           |
|        | IPMI 2.0 or equivalent Support with KVM and Media over LAN features. Must include any licenses, if required for using these features  |  |              |            |           |
|        | Form factor - 1U or better full width server form factor with sliding rack mount kit and peripherals  |  |              |            |           |
|        | Compute connectivity as per Item no – 6   |  |              |            |           |
|        | 80 Plus platinum or better redundant power supply with IEC C13 to IEC C14 cables  |  |              |            |           |
| 3      | Compute Nodes   | 30 Nos. (Minimum 256 cores per node) or As per core density per node quoted by bidders for a total of 7680 Cores |              |            |           |

Each compute nodes should have minimum 256 or better AMD EPYC 4th generation CPU Cores or higher with a minimum base clock speed of 2.25 GHz or better. The processors Must have Native support of AVX2 instructions or better. Each node should have a memory of minimum 3 GB/Core DDR5 ECC RAM or better in a fully balanced configuration with populating all DIMM slots to its fully available bandwidth. RAM speed should be the maximum memory speed supported by the quoted CPUs. The bidders should run linpack across all nodes for 24 hours and submit the results as a part of commissioning. Along with the CPU ratings, the nodes should have the following configurations or better. **CPU Details** Memory Details 1 x 120 GB Enterprise M.2 PCIE Gen4 SSD for operating System and local scratch 2 x 1 G Ethernet Ports 1 x IPMI 2.0 or equivalent with KVM and media over LAN features Preferred Form factor - 1U servers in a chassis with sliding rack mount kit and peripherals. The maximum allowed form factor is 2U chassis with full width servers in a chassis with sliding rack mount kit 80 Plus platinum or better dual (preferably redundant) power supply with required IEC C13 to IEC C14 cables. Compute connectivity as per Item no - 6 1 **Dual controller ZFS compute Storage** 2 Nos of storage controller servers should have minimum 16 AMD EPYC 4th or higher generation CPU Cores with minimum base clock speed of 3.0 GHz or better. The processors Must have Native support of AVX 256 instructions or better. Both the servers should be configured in High Availability mode for failover and it should be installed and configured as storage using latest stable open ZFS according to the user requirements. Along with CPU specifications, the node should have the following configurations or better **CPU** Details Memory Details - 768 GB DDR5 ECC RAM in a fully balanced configuration with populating all DIMM slots to its fully available bandwidth. Memory speed - Maximum memory speed supported by the quoted CPUs. 2 x 120 GB Enterprise 3 DWPD SAS SSD configured in RAID 1 for latest stable Centos/Debian Operating System SAS SSD 2 x 960 GB Enterprise 3 DWPD

configured in RAID 1 for L2ARC

|  |  |  | 1  |  |
|--|--|--|--|--|
| 2 x 960 GB Enterprise 3 DWPD SAS SSD configured in RAID 1 for ZIL  |  |  |  |  |
| 60 x 20 TB NL-SAS 7.2K RPM Hard drives configured in RAID Z2 with maximum 11 Hard Drives per RAID group and remaining Hard drives should be configured as global hot spares.   |  |  |  |  |
| 2 x Compatible HBA 12 Gbps SAS expander kit with its associated accessories for connecting all the JBODs in High Availability (HA) mode.   |  |  |  |  |
| 1 x 5U/4U 84 Bay Dual controllers JBOD or better with Redundant Power Supply and IPMI connectivity for management.   |  |  |  |  |
| 2 x 1 G Ethernet Ports   |  |  |  |  |
| 1 x IPMI 2.0 or equivalent with KVM and media over LAN features  |  |  |  |  |
| Form factor - 1U or better full width server form factor with sliding rack mount kit and peripherals   |  |  |  |  |
| Compute connectivity as per Item no – 6  |  |  |  |  |
| 00 Pl 1 1 1  |  |  |  |  |
| 80 Plus platinum or better redundant power supply with IEC C13 to IEC C14 cables   |  |  |  |  |
| •  |  |  |  |  |
| supply with IEC C13 to IEC C14 cables  BeeGFS based Parallel File System (PFS) with following specifications  Storage Servers (SS) and Meta Data Servers   | 4 Nos  |  |  |  |
| supply with IEC C13 to IEC C14 cables  BeeGFS based Parallel File System (PFS) with following specifications   | 4 Nos  |  |  |  |
| BeeGFS based Parallel File System (PFS) with following specifications  Storage Servers (SS) and Meta Data Servers (MGS/MDS)  CPU Details - 32 AMD EPYC 4th or higher generation CPU Cores with minimum base clock speed of 2.7 GHz or better  Memory Details - 384 GB DDR5 ECC RAM in a fully balanced configuration with populating all DIMM slots to its fully available bandwidth. Memory speed - Maximum memory speed  | 4 Nos  |  |  |  |
| supply with IEC C13 to IEC C14 cables  BeeGFS based Parallel File System (PFS) with following specifications  Storage Servers (SS) and Meta Data Servers (MGS/MDS)  CPU Details - 32 AMD EPYC 4th or higher generation CPU Cores with minimum base clock speed of 2.7 GHz or better  Memory Details - 384 GB DDR5 ECC RAM in a fully balanced configuration with populating all DIMM slots to its fully available bandwidth.   | 4 Nos  |  |  |  |
| BeeGFS based Parallel File System (PFS) with following specifications  Storage Servers (SS) and Meta Data Servers (MGS/MDS)  CPU Details - 32 AMD EPYC 4th or higher generation CPU Cores with minimum base clock speed of 2.7 GHz or better  Memory Details - 384 GB DDR5 ECC RAM in a fully balanced configuration with populating all DIMM slots to its fully available bandwidth. Memory speed - Maximum memory speed supported by the quoted CPUs.  2 x 480 GB Enterprise 3 DWPD SAS SSD configured in RAID 1 for latest stable Rocky Linux Operating System  Both the SS and MDS should be configured in High Availability mode  | 4 Nos  |  |  |  |
| BeeGFS based Parallel File System (PFS) with following specifications  Storage Servers (SS) and Meta Data Servers (MGS/MDS)  CPU Details - 32 AMD EPYC 4th or higher generation CPU Cores with minimum base clock speed of 2.7 GHz or better  Memory Details - 384 GB DDR5 ECC RAM in a fully balanced configuration with populating all DIMM slots to its fully available bandwidth. Memory speed - Maximum memory speed supported by the quoted CPUs.  2 x 480 GB Enterprise 3 DWPD SAS SSD configured in RAID 1 for latest stable Rocky Linux Operating System  Both the SS and MDS should be configured in High Availability mode  Storage should be working in full capacity even when only one MDS and SS is operational | 4 Nos  |  |  |  |
| BeeGFS based Parallel File System (PFS) with following specifications  Storage Servers (SS) and Meta Data Servers (MGS/MDS)  CPU Details - 32 AMD EPYC 4th or higher generation CPU Cores with minimum base clock speed of 2.7 GHz or better  Memory Details - 384 GB DDR5 ECC RAM in a fully balanced configuration with populating all DIMM slots to its fully available bandwidth. Memory speed - Maximum memory speed supported by the quoted CPUs.  2 x 480 GB Enterprise 3 DWPD SAS SSD configured in RAID 1 for latest stable Rocky Linux Operating System  Both the SS and MDS should be configured in High Availability mode  Storage should be working in full capacity even   | 4 Nos  |  |  |  |
|  | configured in RAID Z2 with maximum 11 Hard Drives per RAID group and remaining Hard drives should be configured as global hot spares.  2 x Compatible HBA 12 Gbps SAS expander kit with its associated accessories for connecting all the JBODs in High Availability (HA) mode.  1 x 5U/4U 84 Bay Dual controllers JBOD or better with Redundant Power Supply and IPMI connectivity for management.  2 x 1 G Ethernet Ports  1 x IPMI 2.0 or equivalent with KVM and media over LAN features  Form factor - 1U or better full width server form factor with sliding rack mount kit and peripherals | configured in RAID Z2 with maximum 11 Hard Drives per RAID group and remaining Hard drives should be configured as global hot spares.  2 x Compatible HBA 12 Gbps SAS expander kit with its associated accessories for connecting all the JBODs in High Availability (HA) mode.  1 x 5U/4U 84 Bay Dual controllers JBOD or better with Redundant Power Supply and IPMI connectivity for management.  2 x 1 G Ethernet Ports  1 x IPMI 2.0 or equivalent with KVM and media over LAN features  Form factor - 1U or better full width server form factor with sliding rack mount kit and peripherals | configured in RAID Z2 with maximum 11 Hard Drives per RAID group and remaining Hard drives should be configured as global hot spares.  2 x Compatible HBA 12 Gbps SAS expander kit with its associated accessories for connecting all the JBODs in High Availability (HA) mode.  1 x 5U/4U 84 Bay Dual controllers JBOD or better with Redundant Power Supply and IPMI connectivity for management.  2 x 1 G Ethernet Ports  1 x IPMI 2.0 or equivalent with KVM and media over LAN features  Form factor - 1U or better full width server form factor with sliding rack mount kit and peripherals | configured in RAID Z2 with maximum 11 Hard Drives per RAID group and remaining Hard drives should be configured as global hot spares.  2 x Compatible HBA 12 Gbps SAS expander kit with its associated accessories for connecting all the JBODs in High Availability (HA) mode.  1 x 5U/4U 84 Bay Dual controllers JBOD or better with Redundant Power Supply and IPMI connectivity for management.  2 x 1 G Ethernet Ports  1 x IPMI 2.0 or equivalent with KVM and media over LAN features  Form factor - 1U or better full width server form factor with sliding rack mount kit and peripherals |

|     | G 1  |      | 1 |  |
|-----|--|------|---|--|
|     | configured inside MDS servers  Required FC/HBA 12 Gbps SAS expander kit with its associated accessories for connecting all the JBODs in High Availability (HA) mode.   |      |   |  |
|     | 2 x 1 G Ethernet Ports   |      |   |  |
|     | 1 x IPMI 2.0 or equivalent with KVM and media over LAN features  |      |   |  |
|     | Preferred Form factor - 1U servers in a chassis with sliding rack mount kit and peripherals.   |      |   |  |
|     | The maximum allowed form factor is 2U chassis with full width servers in a chassis with sliding rack mount kit   |      |   |  |
|     | 80 Plus platinum or better dual (preferably redundant) power supply with required IEC C13 to IEC C14 cables.   |      |   |  |
|     | compute connectivity as per quoted Item no – 6   |      |   |  |
| 5.2 | Storage for BeeGFS Storage Targets (ST), Meta<br>Data Targets (MDT) with general<br>specifications of the PFS  | 1 No |   |  |
|     | MDT and ST must be on the same storage. Disk storage dual controller with minimum 8 GB Cache per Controller and it should have minimum 4 Nos of 12 Gbps SAS Adapter or better per controller to achieve HA and JBOD with required accessories also to be included for achieving the requirements as per tender with High Availability. |      |   |  |
|     | Provided JBODs should support minimum 84 Nos of 3.5" inch drives or better and it should have dual controllers with dedicated IPMI management ports.   |      |   |  |
|     | 1 PiB Petabyte usable capacity using 20 TB NL-SAS Helium filled drives or higher in RAID 6 configuration (9D + 2P) with RAID group size not more than 11 disks per RAID group.   |      |   |  |
|     | Metadata storage should be minimum 2% of the capacity of usable space using minimum 3.8 TiB or better Enterprise SAS SSD drives configured in linear RAID 1 group with 2 disks per RAID group.   |      |   |  |
|     | Global Hot Spare Disks for Storage Targets (ST) and Meta Data Targets (MDT): Disks amounting to 10% of total capacity to be provided as global   |      |   |  |

| hot spare.  |  |
|---|--|
| The parallel File system must be based on the latest stable version of BeeGFS.  |  |
| Open-source IOR/IO Zone benchmarks running on compute nodes with 1MB block size and file size double than total storage cache and I/O node memory. As a part of acceptance test, Benchmarks should be run and submitted with I/O measured from client (compute node) using IOR benchmark for minimum 4 GB/s write throughput. |  |
| 2 Nos of SS Servers should be connected in HA for redundancy  |  |
| 2 Nos of MDS Servers should be connected in HA for redundancy   |  |
| MDT should be mounted only with the MDS server.   |  |
| ST should be mounted only with SS servers.  |  |
| For MDT Failover, MDS Nodes should be configured with active/passive pair.  |  |
| For ST Failover, SS Nodes should be configured with active/active pair.   |  |
| MDT storage should be populated with Enterprise 3DWPD SAS SSD drives.   |  |
| PFS must support multi-tenancy to deliver parallel data access across the whole file system securely to separate tenants.   |  |
| PFS must support the Checksum/ECC facility.   |  |
| PFS MUST support the ability to create temporary parallel file system instances on a perjob basis on internal SSDs / NVMe of compute nodes, which are part of a compute job to integrate with cluster batch systems.  |  |
| File system should not go down, even if one of the MDS or OSS nodes fails.  |  |

|   | PFS must support Access Control Lists (ACLs)   |   |  |  |
|---|--|---|--|--|
|   | High Availability should be automated. No single point of failure in the solution.   |   |  |  |
|   | Failover and MMP (Multiple Mount Protection) should be configured.   |   |  |  |
|   | Storage controllers cache batteries or any other consumables required for the smooth functioning of the storage appliance with hardware and software (BOTH) support need to be included in the warranty. |   |  |  |
|   | Time to time upgradation of parallel file systems (Both server side and client side) should be done whenever there is a patch or new version released, if necessary.                                     |   |  |  |
|   | Any additional licenses required for hardware and software (BOTH) for achieving all of above the features must be included in the tender response.   |   |  |  |
|   | 80 Plus platinum or better dual (preferably redundant) power supply with required IEC C13 to IEC C14 cables.   |   |  |  |
| 6 | Network/Interconnect & Connectivity  | 2 |  |  |
|   | Rack mountable 48 Port unmanaged Gigabit switches with required cables for IPMI management with required peripheral for rack mounting.   | 1 |  |  |
|   | Fully non-blocking 100 G Omnipath/Infiniband HDR 100/Switchless Torus 6D networks with required accessories, cables and network adapter cards for the computing connectivity.                            | 1 |  |  |
|   | Both the compute and management networking switches should have built-in redundant Power supply units  |   |  |  |
|   | Required power cables for the equipment / devices of type - IEC C13/C14 and IEC C19/C20 from OEM should be considered.   |   |  |  |
|   | Note: Cables should be lengthy to connect across racks, in case the cluster load is distributed  |   |  |  |

|            | across multiple racks.  |   |  |  |
|------------|---|---|--|--|
| 7          | KVM Display   | 1 |  |  |
|            | 1U Rack mountable 17" OSD with attached   |   |  |  |
|            | Keyboard & touchpad with USB with accessories   |   |  |  |
|            | to connect with the Primary Master node.  |   |  |  |
| 8          | Fully Automated System Provisioning   | 1 |  |  |
|            | Operating System - Latest stable version of   |   |  |  |
|            | Rocky Linux   |   |  |  |
|            | Clustering tool – xCAT, Warewulf  |   |  |  |
|            | (opensource)/Qlustar/FAI/DevOPs Tools   |   |  |  |
|            | Scheduler – SLURM/Open PBS  |   |  |  |
|            | Scheduler configuration inputs has to be taken  |   |  |  |
|            | from the TIFR-H HPC Committee   |   |  |  |
|            | Cluster management tools - Ganglia, PDSH,   |   |  |  |
|            | PDCP, Nagios, automated emails, automated   |   |  |  |
|            | monthly report generation, etc., TIFR-H HPC   |   |  |  |
|            | System Administrators will be providing inputs  |   |  |  |
|            | for the other required management tools and   |   |  |  |
|            | functionalities during installation. <b>Ticketing Tool</b> – The bidder should install and  |   |  |  |
|            | configure OS Ticket or RT and integrate with  |   |  |  |
|            | their ticketing email for a dedicated local   |   |  |  |
|            | ticketing management.   |   |  |  |
| 9          | Software  |   |  |  |
| 1 <b>9</b> |   | 1 |  |  |
| 9          |   | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS,  | 1 |  |  |
| 9          | Open Source Application Software list for   | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS,  | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python,  | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev,  | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk,  | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis.   | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC,  | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC, VMD, Perl, etc.,   | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS, CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC, VMD, Perl, etc., Compilers and Libraries: OpenMP, MPI, C/C++  | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC, VMD, Perl, etc., Compilers and Libraries: OpenMP, MPI, C/C++ and FORTRAN compilers, gsl libraries should be  | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC, VMD, Perl, etc., Compilers and Libraries: OpenMP, MPI, C/C++ and FORTRAN compilers, gsl libraries should be installed.   | 1 |  |  |
| 9          | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS, CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC, VMD, Perl, etc., Compilers and Libraries: OpenMP, MPI, C/C++ and FORTRAN compilers, gsl libraries should be installed.  Note - Commercial software mentioned in the list  | 1 |  |  |
| 10         | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC, VMD, Perl, etc., Compilers and Libraries: OpenMP, MPI, C/C++ and FORTRAN compilers, gsl libraries should be installed.   | 1 |  |  |
|            | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC, VMD, Perl, etc., Compilers and Libraries: OpenMP, MPI, C/C++ and FORTRAN compilers, gsl libraries should be installed. Note - Commercial software mentioned in the list will be provided by TIFR-H. Warranty, Support, Terms & Conditions  |   |  |  |
| 10         | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC, VMD, Perl, etc., Compilers and Libraries: OpenMP, MPI, C/C++ and FORTRAN compilers, gsl libraries should be installed.  Note - Commercial software mentioned in the list will be provided by TIFR-H.  Warranty, Support, Terms & Conditions  | 1 |  |  |
| 10         | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC, VMD, Perl, etc., Compilers and Libraries: OpenMP, MPI, C/C++ and FORTRAN compilers, gsl libraries should be installed. Note - Commercial software mentioned in the list will be provided by TIFR-H. Warranty, Support, Terms & Conditions Comprehensive onsite hardware and  | 1 |  |  |
| 10         | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS, CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC, VMD, Perl, etc., Compilers and Libraries: OpenMP, MPI, C/C++ and FORTRAN compilers, gsl libraries should be installed. Note - Commercial software mentioned in the list will be provided by TIFR-H. Warranty, Support, Terms & Conditions Comprehensive onsite hardware and software warranty for 5 Years   | 1 |  |  |
| 10         | Open Source Application Software list for installation: FFTW, P3DFFT, GERRIS,, LAMMPS, QUANTUM ESPRESSO, NAMD, GROMACS,CP2K, VASP, Gaussian, Amber etc., Scientific programs: Lapack, scalapack, Python, Numpy, SciPy, Setuptools, IPython, pythondev, python numpy, python matplotlib, python tk, python lxml, PyReadline, MDAnalysis. Editors: Vim, Gvim, GNU plot, NTPD, GRACE, BC, VMD, Perl, etc., Compilers and Libraries: OpenMP, MPI, C/C++ and FORTRAN compilers, gsl libraries should be installed. Note - Commercial software mentioned in the list will be provided by TIFR-H. Warranty, Support, Terms & Conditions Comprehensive onsite hardware and software warranty for 5 Years If TIFR-H requests for OS/software upgrade due | 1 |  |  |

| and re-commission the HPCL at any point of time during the warranty period at no cost to purchaser.  Training for general system administration with documentation including tasks such as user/node management, installation/upgrade, queuing system management and file system management.  The OEM/Bidder should have L2/L3 level service engineers in the relevant field of quoted item. Engineer should have experience and complete knowledge of HPC hardware and software used by the users mentioned in the document and he should be able to provide support to the users (8.00 AM to 5.00 PM, 6 Days a week) remotely and Next Business Day (NBD) onsite hardware support.  Vendor/OEM engineer should visit TIFR-H every 120 days and carry out proper hardware & software health check of HPC cluster and submit report of the same to the IT in-charge.  Bidders will be responsible to protect user data during any maintenance during the warranty period.  The OEM/Bidder should have a ticketing system with a dedicated helpdesk email account which is regularly monitored and it should be available to TIFR-H users.  An escalation matrix for issues not resolved by the support personnel, with an expected timeline, should be clearly mentioned.  The person should have enough experience to handle cluster hardware and software troubleshooting to resolve the problems faced by the users. This should heave the problems faced by the users. This should be able to produce required status report of the cluster when asked using the software installed in the cluster when asked using the software installed in the cluster to manage it.  Faulty parts should be replaced by NBD (Next Business Day).  10.2 Documentation  • User Creation/Deletion/Modification.  • Bringing up and shutting down the cluster.  • Disk status monitoring of Master/IO nodes and storage enclosure.                     |          | 1 1 1 1 INDOC 1 1 1 Col                           |  |
|--|----------|---|--|
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| Disk status monitoring of Master/IO nodes  |          | · · · · · · · · · · · · · · · · · · ·             |  |
|  |          |   |  |
| and storage enclosure.   |          |   |  |
|  |          | and storage enclosure.                            |  |

|      | <ul> <li>Basic troubleshooting for storage and job scheduler.</li> <li>Step by step installation guide for node configuration from scratch.</li> <li>When handing over the cluster the vendor should provide the full design of the cluster installation including the electric connections, network connections, user manual clearly explaining how to use the cluster.</li> </ul>  |  |  |
|------|--|--|--|
| 10.3 | Terms and conditions:  |  |  |
|      | Any item not specifically mentioned in the specification but is required for successful implementation of the HPC solution (in the opinion of the vendor) must be brought to our notice and quoted accordingly.  |  |  |
|      | The entire solution should fit in a 19" standard IT Rack.  |  |  |
|      | At the time of installation, if it is found that some additional hardware or software items are required to meet the operational requirement of the configuration, but not included in the vendor's original list of deliverables, the vendor shall supply such items to ensure the completeness of the configuration at no extra cost.  |  |  |
|      | The vendor immediately after the award of the work shall prepare a detailed plan of installation as proposed to be followed by placement of the equipment, etc.  |  |  |
|      | All vendors participating in this tender must visit the TIFR-H site for a complete site survey and also meet with the TIFR-H IT team in the pre-bid meeting for detailed discussions and clarifications, if any.   |  |  |
|      | The installation should be done by experienced and trained engineers for HPCC stack followed by comprehensive user training.   |  |  |
|      | Installation and integration of all supplied hardware and software shall be done by the vendor. The vendor shall install and configure all required hardware and software suites, including but not limited to racking and stacking, Cluster networking, Configuring all nodes, Execution and submission of jobs, Installation of compilers (with flags for optimization) and applications, Configuration of environment variables and |  |  |

| license utility configuration.  |  |
|---|--|
| Entire installation should be done at the   |  |
| proposed site only. Remote control of network   |  |
| will not be given during installation.  |  |
| Give all model numbers of master nodes,   |  |
| compute nodes, hybrid nodes, storage nodes,   |  |
| InfiniBand chassis switch model, Accelerator  |  |
| card details, maximum number of port in IB/OPA  |  |
| switch and how many ports populated. OEM part   |  |
| code of all the equipment / devices proposed should be provided with the technical bid.         |  |
| Provide case logging procedure for both   |  |
| hardware and software failure.  |  |
| OEM/Bidder is responsible for all performance   |  |
| benchmarks and the quote should contain an  |  |
| undertaking certifying the same from the  |  |
| OEM/Bidder.   |  |
| As a part of acceptance test, TIFR-H team will  |  |
| check all the software mentioned above, for at  |  |
| least 3 days. TIFR-H teams will cross-check   |  |
| benchmarking and all other tests based on our   |  |
| input files in the fully offered solution.  |  |
| All LAN cabling should be done on-site as per the   |  |
| length required using CAT6. Do not use factory crimped standard length CAT6 cables. All cabling |  |
| should be done to provide efficient air circulation   |  |
| and should not block any air circulation behind   |  |
| the servers.  |  |
| Please specify the heat dissipation (in BTU) and  |  |
| max power consumption of each component   |  |
| when configured with the above configuration.   |  |
| The bidder has to visit the installation site and   |  |
| provide the plan, cluster rack arrangement and  |  |
| cooling requirements for hosting the HPCC in the  |  |
| given place.  All the required CAT6 Patch cables should be                                      |  |
| branded (ISO/IEC 11801) and it should be  |  |
| molded cables. It should withstand the heat   |  |
| produced at the back of servers.  |  |
| Supplier should have direct system integration  |  |
| (SI) with the OEM whose product the vendor is   |  |
| quoting for. The bidder should have a back-to-  |  |
| back agreement with the OEM to supply and   |  |
| support the OEM's product and solution in India.  |  |
| Itemized price list of each hardware item,  |  |
| software bundle and service and warranty to be  |  |
| given separately and clearly.   |  |

|   |  | · | - | <br>- |
|---|--|---|---|-------|
|   | TIFR-H requires that there be a Single Point of Contact (SPoC) directly from OEM who is responsible for all issues between TIFR-H and the OEM/partner who executes this project. |   |   |       |
|   | SLA of 98% of uptime within 24 hours reporting onsite, failing which penalty will be applicable based on deviation.  |   |   |       |
| ļ |  |   |   |       |
|   | The bidder has to ensure that the solution   |   |   |       |
|   | proposed delivers an uptime of 98% of the entire   |   |   |       |
|   | system on a yearly basis and minimum of 92% on   |   |   |       |
|   | a monthly basis. Every percentage of uptime  |   |   |       |
|   | below 98% on a yearly basis will incur 0.1% of   |   |   |       |
|   | the total cost of this tender. In the event of failure   |   |   |       |
|   | of any of the subsystems or components of the  |   |   |       |
|   | proposed solution, the bidder has to ensure that   |   |   |       |
|   | the defects are rectified within two full working  |   |   |       |
|   | days. All these conditions need to be satisfied.   |   |   |       |
|   | Any delay in servicing node(s) beyond 3 days will  |   |   |       |
|   | incur a penalty of 0.2% of the total cost of this  |   |   |       |
|   | tender per day of delay. Any delay in storage or   |   |   |       |
|   | any of its subsystems not working beyond 24  |   |   |       |
|   | hours will incur a penalty of 0.2% of the total cost   |   |   |       |
|   | of this tender for every completed 24 hours.   |   |   |       |
|   | Bidder should provide complete documentation   |   |   |       |
|   | about the Rack layout, power, cooling and  |   |   |       |
|   | electrical infrastructure required at TIFR-H along   |   |   |       |
|   | with the technical bid.  |   |   |       |
|   | Delivery period will be 30 weeks from the date of  |   |   |       |
|   | purchase order. Once delivered to onsite, the  |   |   |       |
|   | installation, commissioning and acceptance   |   |   |       |
|   | testing period will be within 4 weeks from the   |   |   |       |
|   | date of delivery of equipment. Delay in delivery   |   |   |       |
|   | will have penalty. TIFR-H reserves the right to  |   |   |       |
|   | cancel the order if it is not deployed even after  |   |   |       |
|   | that.  |   |   |       |
|   | Delay due to TIFR-H will not be considered for   |   |   |       |
|   | computing penalty.   |   |   |       |

#### **NOTE:**

- \* The bidder should ensure to submit the following along with Technical Bid (Part I)
- 1. The bidder should attach the point-by-point technical specification provided in Annexure-A of the tender document (with additional remarks if any) along with the Technical Bid.
- 2. Bid Security / EMD (Earnest Money Deposit) as per tender.

- 3. Certificate of Local Content- Attachment of Annexure B.
- 4. Audited Annual Turnover Certified by CA Attachment of Annexure C
- 5. Supplier Purchase Order details with copy document along with the bid Attachment of Annexure D.
- 6. The suppliers/bidders should submit all the applicable list of documents/enclosures/annexures as mentioned in the tender along with the local content certificate filled form as per annexure B. The supplier should provide the local content details / local value addition details with the applicable value. TIFR Hyderabad reserves the right to reject any tender (or) all tenders if not submitted along with the documents/enclosures/annexures/certificate of local content.
- 7. Undertaking by the bidder as per Clause 14 of tender terms and conditions in letter head duly signed and stamped.
- 8. Undertaking for unconditional acceptance of tenders all terms and condition in letter head duly signed and stamped.
- \* Price Bid/Finance Bid (Part II) As per Annexure E.

### TATA INSTITUTE OF FUNDAMENTAL RESEARCH HYDERABAD

Plot No.36/P, Gopanpally Village, Serilingampally Mandal, Ranga Reddy District. Hyderabad - 500 107, Telangana, India. (PURCHASE SECTION)

1. PART "A" (Technical Bid) consisting of Technical Bid with Commercial Terms and PART "B" (Financial Bid) consisting of only Price shall be submitted in separate sealed envelopes duly superscribed with the tender enquiry number, and the due date in bold letters, addressed to the Administrative Officer, Tata Institute of Fundamental Research, Hyderabad, Plot No.36/P, GopanpallyVillage, Serilingampally Mandal, Ranga Reddy District. Hyderabad-500 107, Telangana, India. The envelopes should be clearly marked on top as either PART "A" or PART "B".

The two sealed covers should be further put in a master cover superscribed with the Tender Enquiry No., Due Date in bold letters, addressed to the Administrative Officer (Purchase Section), TataInstitute of Fundamental Research, Hyderabad, Plot No.36/P, Gopanpally Village, Serilingampally Mandal, Ranga Reddy District. Hyderabad-500 107, Telangana, India. The sealed master envelop has to be delivered by hand/courier at the security Gate Office of TIFR Hyderabad on or before 13.00 hrs. on the due date specified. The technical bid will be opened at 15.00 hrs. on the due date at Purchase Section, TIFR, Hyderabad. Tenders submitted after 13.00 hrs. on due date will not be considered.

Note: All future corrigendum/addendum will be published in CPPP/TIFR Hyderabad website.

All prospective bidders are requested to visit our website regularly for any such updates/Corrigendum.

Pre- Bid meeting will be conducted through online. Bidders are requested to refer TIFR Hyderabad website tender page for pre-bid meeting zoom link. Bidder may also join the meeting on scheduled date and time at TIFR Hyderabad premises.

- 2. In case the PART "A" and Part "B" bids are not sealed in separate envelopes thetender will be rejected.
- 3. The technical bid should not contain any indication of the price. The bidder should take special care not to mention anything related to pricing and costing aspect of whatsoever nature. The technical bid should include/contain only technical specifications, technical literature, drawing, quantity, manufacturing and delivery schedule, mode and terms of payment, mode of dispatch, the quantum and percentage of statutory levies payable by the purchaser as extra and all related commercial terms and conditions for the supply and for the services like erection and commissioning to be rendered by the tenderer. The details of the validity of the tender should also be indicated along with the commercial details.

- 4. After scrutiny of Technical Bids, Financial bids of only those bidders who are shortlisted on technical basis will be opened at on later date. The opening date, time and venue will be intimated to the technically successful bidder.
- 5. All the bidders/contractors should provide Company Authorization Letter duly signed and stamped by Competent Authority to participate in the tender related meetings at TIFR Hyderabad.

#### 6. **Tender Fee:**

Tender fee of Rs. 00 (USD 00)

#### 7. Bid Security / EMD (Earnest Money Deposit):

Earnest Money Deposit (EMD) for **Rs. 15,00,000.00** in the form of D.D. in favor of "Tata Institute of Fundamental Research", payable at Hyderabad to be enclosed along with the technical Bid (Part - A).

The Bid Security may be accepted in the form of Bank Guarantee from any of the Commercial Banks (or) Fixed Deposit Receipt (FDR) (or) Banker's Cheque from any of the Commercial Banks (or) Insurance Surety Bonds.

The Bid security should remain valid for a period of 45 days beyond the final bid validity period.

EMD shall be interest free and it will be refunded to the unsuccessful bidder without any interest. EMD will be forfeited if the bidder withdraws or amend impairs or derogates from the tender in any respect. **The technical bid received without payment of EMD/documents for exemption of EMD shall be summarily rejected**.

- 8. The Micro and Small Enterprises/Startups suppliers / bidders whose firms are registered with MSME /DPIIT and having a valid certificate for claiming exemption as per privilege rules of Government of India are exempted from paying Tender Fee and EMD (Earnest Money Deposit).
- 9. Quotations must be valid for a period of 180 days from the date of opening the bid prescribed by the Purchaser. A bid valid for a shorter period may be rejected by the Purchaser as non-responsive.
- 10. Tenders containing correction, overwriting will not be considered. Late or delayed/Unsolicited quotations/offers shall not be considered at all. These will be returned to the firms as it is. Post tender revisions/corrections shall also not be considered.
- 11. Tenderer should sign on all the pages of the technical bid and the price bid.
- 12. Bidders should submit undertaking for unconditional acceptance of tender all terms and conditions in letterhead duly signed and stamped.
- 13. All future corrigendum will be published in CPPP/TIFR Hyderabad website only and no separate advertisement will be released for the same.

All prospective bidders are requested to visit our website regularly for any such updates / Corrigendum. The Purchaser reserves the right to reject the bids if the bids are submitted without taking into account these amendments/clarifications In order to allow prospective bidders reasonable time in which to take the amendment into account in preparing their bids, the Purchaser, at its discretion, may extend the deadline for the submission of bids.

14. **Requirement from Bidders:** Any bidder from a country which shares a land border with India will be eligible to bid in any procurement whether of goods, services (including consultancy services and non-consultancy services) or works (including turnkey projects) only if the bidder is registered with the Competent Authority as per order issued by the Government of India (Order No. F.No.6/18/2019-PPD dated 23rd July, 2020 and further applicable Notification / Rule amended from time to time).

"Bidder" means any person or firm or company, including any member of consortiumor joint venture (that is an association of several persons, or firms or companies), every artificial juridical person not falling in any of the descriptions of bidders stated herein before, including any agency branch or office controlled by such person, participating in a procurement process.

Necessary certificate/undertaking to be submitted.

15. Order Acceptance: The successful bidder should submit acceptance of Purchase Order immediately (within 15 days) from the date of issue of the Purchase Order failing which it shall be presumed that the vendor is not interested.

The Bidder should submitted the order acknowledgement, (details for opening L/C and documents if applicable) and documents if any to purchase section within 15 days from the date of issue of purchase order.

For Letter of Credit (L/C) payment, the Letter of Credit (L/C) will be opened as per purchase order terms and conditions only. The supplier should ensure to deliver and complete the installation as per purchase order terms and conditions within Letter of Credit (L/C) validity period. In case of any delay in supply or installation or submission of required documents by the supplier for Letter of Credit (L/C) payment, any applicable charges to be borne by the supplier only. The Letter of Credit (L/C) amendment charges if any due to delay of the supplier to be borne by the supplier only.

The Supplier should submit the invoice and packing list before dispatch of the material for confirmation of TIFR Hyderabad.

Any discrepancy like delay in supply/ short supply/delay in installation etc., TIFR Hyderabad has right not to process the payment in case of any such discrepancy.

- 16. Performance Security: The Successful bidder should deposit @ 5% of Purchase Order value as Performance Security. The Performance Security should be in the form of Demand Draft in favour of "Tata Institute of Fundamental Research" payable at Hyderabad from any of the Commercial Banks (or) Bank Guarantee from any of the Commercial Banks (or) Fixed Deposit Receipt (FDR) (or) Insurance Surety Bonds. The Performance Security @ 5% should be valid for a period of 60 days beyond the date of completion of all contractual obligations of the supplier including warranty period. In case Performance Security @ 5% is not provided, then 95% payment only would be released and balance after 60 days beyond the date of completion of all contractual obligations of the supplier including warranty period. Vendor should clearly mention their acceptance to this effect in their quote.
- 17. Payment Terms for Import Items: 100% irrevocable Letter of Credit (L/C) will be opened. 80% payment shall be made through irrevocable Letter of Credit (L/C) against submission of clear shipping documents and balance 20% of the amount shall be released through irrevocable Letter of credit (L/C) after successful installation, acceptance of the equipment certified by TIFR Hyderabad and on submission of "Performance Security" for an amount equivalent to 5% of the Purchase Order Value.
- 18. <u>Payment Terms for Indigenous Items</u>: 100% payment shall be released after receipt ofcomplete material as per purchase order in a single lot, successful installation and acceptance of the equipment certified by TIFR Hyderabad and on submission of "Performance Security" for an amount equivalent to 5% of the Purchase Order Value.
- 19. In case of Letter of Credit (L/C) payment, the Letter of Credit (L/C) will be opened as per purchase order terms and conditions only. The supplier should ensure to deliver and complete the installation as per purchase order terms and conditions within Letter of Credit (L/C) validity period. In case of any delay in supply or installation or submission of required documents by the supplier for Letter of Credit (L/C) payment, any applicable charges to be borne by the supplier only. The Letter of Credit (L/C) amendment charges if any due to delay of the supplier to be borne by the supplier only.
- 20. Partial shipment for foreign bids / Partial delivery of material for full INR bids will not be accepted by TIFR Hyderabad.
- 21. **Pre Inspection Report:** The successful bidder should submit the Pre Inspection Report / Manufacturer's Test Certificate with data sheet to TIFR Hyderabad before dispatch of the material at no extra cost to the purchaser. (if required by TIFR Hyderabad).
- 22. Repair / replacement if required any during the warranty period, necessary customs clearance charges / customs duty charges, freight charges for sending back the repair material to supplier and import freight charges of replacement should be borne by the supplier.
- 23. For Import cases: No Agency commission will be paid as per Govt. of India rules.
- 24. All bank charges outside India will be to supplier's account only.

25. Taxes: TIFR Hyderabad is a Public Funded Research Institute. The exemption of Customs Duty under the notification No. 51/96 dated 23.07.1996 and amended time to time will be applicable.

GST with effect from 01.07.2017 and amended time to time will be applicable. The applicable TDS / other charges if any as per GST rule will be deducted as per new GST regime.

TIFR Hyderabad GST NO: 36AAATT3951F2ZG.

Deduction of Indian Income Tax Deduction at Source: The Deduction of Indian Income Tax Deduction at source (TDS) will be deducted as per IT Act. The taxes at the time of actual utilization of service etc. will be deducted if applicable any.

Supplier shall be entirely responsible for all taxes, duties, license fees, road permits, etc., incurred until delivery of the contracted Goods to the purchaser. However, GST in respect of the transaction between the Purchaser and the Supplier shall be payable as agreed, if so stipulated in the order.

- 26. **Delivery Period:** Within 30 weeks from the date of release of Purchase Order.
- 27. **Installation Period:** The Installation should be completed within 4 weeks from the date of receipt of the material at TIFR Hyderabad.

#### 28. Training:

- i) The Supplier is required to train designated Purchaser's technical and end user personnel to enable them to effectively operate the total equipment.
- ii) The training shall be initially carried out during installation & commissioning for operating and maintaining the system. The specific training on application shall also to be imparted by the supplier. The duration of such training need to be finalized with the end user of the equipment. The supplier has to provide complete training at site for operation (including trouble shooting) of the instrument.
- iii) In case any supplier is not willing to impart such training, the bid shall be treated as non-responsive.

#### 29. Liquidated Damages (LD):

The Supplier shall arrange to ship the ordered materials within the mutually agreed delivery period mentioned in the order unless extended with/without penalty. Please mention the Delivery Period Clearly in the Bid, however effort to be taken to deliver thematerials at the earliest.

In case of delay in supply on part of the supplier, a penalty @0.5% per week of order value will be charged for delayed period subject to a maximum of 10% order value.

If the delay in the shipment of the ordered materials attributable to the supplier exceeds agreed time period from the date of original agreed upon date of shipment and extended with/without penalty, the TIFR Hyderabad shall have the right to cancel the contract / purchase order and recover the liquidated damages from other dues of the party or by legal means. It will also affect the other/future business dealings with such suppliers.

The same rate of penalty shall be applicable for late installation of the equipment/instrument also.

#### 30. Eligibility Criteria:

- i) The invitation for bids is open to Original Manufactures (OEM)/Authorized Dealers/Authorized Distributors/Subsidiary Indian Company of the OEM/Indian Agent on behalf of the Foreign Manufacturer or Principals of the tendered equipment. The bidder must be legal entity having a Permanent Account Number (PAN), Certificate of Incorporation and valid GST Registration Certificate is to be submitted.
- ii) The invitation is reserved only for Class "1" and Class "2" Local Suppliers as prescribed in "Public Procurement (Preference to Make in India) order 2017 of GOI, Dept. of DIPP" (OM No. P-45021/2/2017-PP(BE-II) dated 04th June, 2020.Necessary certification for local content must be submitted by the prospective bidders strictly as per the Annexure-B attached with the tender document.
- iii) When a firm sends quotation for an item manufactured by some different company, the firm is also required to attach its quotation, the manufacturer's authorization certificate.
- iv) Indian Agent cannot represent two different foreign principles for the same item in one tender.
- v) Equipment's must be of the most recent series/models incorporating the latestimprovements in design.
- vi) That the Bidder will assume total responsibility for fault free operation of equipment, application software, if any, and maintenance during the warranty period and provide necessary maintenance services after warranty period if required.
- vii) Bidders who meet the criteria given above are subject to be disqualified, if they have made untrue or false representation in the forms, statements and attachments submitted in proof of the qualification requirements or have a record of poor performance, not properly completing the contract, inordinate delays in completion or financial failure, etc.
- viii) Any additional bid participation criteria/eligibility conditions etc. mentioned in the Technical Specifications sheet will also form part of the Qualification Requirements along with those mentioned in this.
- ix) Bidders should not be associated, or have been associated in the past, directly or indirectly, with a firm or any of its affiliates which have been engaged by the

Purchaser to provide consulting services for the preparation of the design, specifications, and other documents to be used for the procurement of the goods to be purchased under this invitation of Bids.

#### 31. Purchase Preference Policies.

- The TIFR Hyderabad intends to give product reservation/purchase/price preference to local suppliers in line with current procurement policies of Govt. of India
- ii) For the above purpose, local supplier means a supplier or service provider whose product or service offered for procurement meets the minimum local content as prescribed in "Public Procurement (Preference to Make in India) order 2017 of GOI, Dept of DIPP" (OM No. P-45021/2/2017-PP(BE-II) dated 04th June 2020. Necessary certification for local content must be submitted by the prospective bidders strictly as per the Annexure B attached with the tender document.
- iii) Local content means the amount of value added in India which shall, unless otherwise prescribed by the Nodal Ministry, be the total value of the items procured (excluding net domestic indirect taxes) minus the value of imported content in the item (including all customs duties) as a proportion of the total value, in percent.
- 32. Bidders who have not accepted the job/order awarded to them or withdrawn from the tender process OR whose EMD/Security deposit has been forfeited in the past, their bids will not be considered and treated as ineligible / disqualified.
- 33.Bidders may provide the details of registration at Government e -Marketplace (GeM) product details, confirmation on the product availability (or) non availability in GeM, registered bidder at GeM (or) not.

#### 34. Micro and Small Enterprises (MSEs):

Micro and Small Enterprises (MSE) must, along with their offer, provide proof of their being registered as MSE (indicating the terminal validity date of their registration) with any agency mentioned in the notification of the Ministry of Micro, Small and Medium Enterprises (Ministry of MSME).

The Micro and Small Enterprises (MSE) are exempted from payment of earnest money and tender fees subject to furnishing of relevant valid certificate for claiming exemption as per privilege rules of Government of India. Public procurement Policy (PPP) for MSEs Order, 2012 is meant for procurement of only goods produced and services rendered by MSEs However, Traders, Distributers, Sole agents, work contracts are excluded from the purview of the PPP for MSE Order 2012 as per Ministry of MSME.

The Micro and Small Enterprises (MSE) bidder should submits valid UDYAM Registration certificate by Ministry of Micro Small and Medium Enterprises (MSME). The Micro and Small Enterprises (MSE) bidders who fail to submit valid UDYAM Registration certificate shall not be able to avail the benefits available to MSEs as contained in Public Procurement Policy for MSEs Order 2012 issued by MSME and further applicable

Notification / Rule amended from time to time.

- 35. For Indigenous Items: Offer should be on FOR basis and mentioned separately using different table format showing all the applicable taxes/Duties like GST, Freight & Transportation charges and installation charges etc.
- 36. The price quoted for Import item must be on following basis:
  - a. Ex-Work/factory duly packed airworthy/seaworthy and of international standard
  - b. FOB/FCA
  - c. CIF Hyderabad, Airport Port (all-inclusive i.e. Cost of Goods, Packing, Insurance, Inland transportation, freight etc.)

For local item /supply, offer should be on FOR basis (i.e. total landed cost for delivery at TIFR Hyderabad).

The dimension of the item (viz. H, W, L, weight etc.) shall be specifically stated and also mention whether the mode of shipping the item is Airworthiness / Seaworthiness or both. Accordingly the mode of shipment will be decided by TIFR Hyderabad.

# Price must be quoted strictly in the Price Bid Format attached herewith as "Part -B" (Financial Bid).

- 37. Packing: Standard Packing
  - i) The Supplier shall provide packing of the Goods as is required to prevent their damage or deterioration during transit to their final destination as indicated in the Contract. The packing shall be sufficient to withstand, without limitation, rough handling during transit and exposure to extreme temperatures, salt and precipitation during transit and open storage. Packing case size and weights shall take into consideration, where appropriate, the remoteness of the Goods' final destination and the absence of heavy handling facilities at all points in transit.
  - ii) The packing, marking and documentation within and outside the packages shall comply strictly with such special requirements as shall be provided for in the Contract including additional requirements, if any and in any subsequent instructions ordered by the Purchaser.
  - iii) Packing Instructions: Each package will be marked on three sides with proper paint/indelible ink, the following:
  - (A) Item Nomenclature
  - (B) Order/Contract No.
  - (C) Country of Origin of Goods
  - (D) Supplier's Name and Address
  - (E) Packing list reference number

#### 38. Insurance:

- i) The Goods supplied under the Contract shall be fully insured against loss or damage Incidental to manufacture or acquisition, transportation, storage and delivery.
- ii) For delivery of goods at the purchaser's premises, the insurance shall be obtained by the Supplier in an amount equal to 110% of the value of the goods from "Warehouse to warehouse" (Final destinations) on "All Risks" The Insurance shall be valid for a period of not less three months after installation and commissioning. However, in case of orders placed on EX-Works/FOB/FCA basis, the purchaser shall arrange insurance.

#### 39. Delivery and Documents:

- A) Delivery of the Goods shall be made by the Supplier in accordance with the terms specified by the Purchaser in the order within the period. The details of shipping and/or otherdocuments to be furnished the supplier are specified below.
- B) Delivery period (As stated in technical specifications).

The delivery is to be strictly made as per the delivery schedule stated in the Purchase Order.

The following documents are to be forwarded earlier to TIFR Hyderabad through email to <a href="mailto:purchasegroup@tifrh.res.in">purchasegroup@tifrh.res.in</a> prior to 48 hours before dispatch of material.

- i) Supplier Invoice showing Purchase Order Number, goods' description, quantity, unit price, Total amount.
- ii) Packing List
- iii) Airway Bill/ Acknowledgement of receipt of goods from the consignee(s) by the Transport with item wise weight, unit of measurement, No of package, package size/Dimension.
- iv) Insurance Certificate.
- v) Manufacturer's / Supplier's warranty certificate.
- vi) Inspection Certificate issued by the nominated inspection agency, if any, and Certificate of Origin.
- vii) Country of Origin Certificate.
- viii) Product Catalogue/Brochure.
- 40. The Institute shall be under no obligation to accept the lowest or any other tender received in response to this tender notice and shall be entitled to reject any tender without assigning any reason whatsoever.
- 41. Conversion to Single Currency: To facilitate evaluation and comparison, the Purchaser will convert all bid prices are payable to Indian Rupees established by any bank in India as notified in the Newspapers/banks website on the date of Price/Finance Bid Opening.

#### 42. Evaluation & Comparison of Bids:

- (A) For the bids qualifying for the technical evaluation which have been found to be responsive the evaluation & comparison shall be made as under:
- (i) Indigenous Offers: The final landed cost of purchase after all discounts, freight, forwarding, insurance (warehouse to warehouse), custom clearing charges taxes, etc. shall be the basis of evaluation.

#### (ii) Imported Offers:

The CIP/CIF price shall be the basis of evaluation (warehouse to warehouse basis)

(iii) Imported Vs. Indigenous Offers:

The final landed cost (warehouse to warehouse) of purchase taking into account, freight, forwarding, insurance, taxes, etc. (CIF/CIP with custom duty, customs clearance charges, Bank/LC charges, transportation, delivery up to the site of installation at TIFR Hyderabadas per available records with TIFR Hyderabad for imported goods) shall be the basis of evaluation.

- (B) Conditional tenders/discounts etc. shall not be accepted. Rates quoted without attached conditions (viz. Discount shaving linkages to quantity, payment terms etc.) will only be considered for evaluation purpose. Thus conditional discounted rates linked to quantities and prompt/advance payment etc., will be ignored for determining inter-se position. The Purchaser however reserves the right to use the discounted rate/rates considered workable and appropriate for counter offer to the successful tenderers.
- 43. Contacting the Purchaser: Any attempt by any Bidder to influence the Purchaser in its decisions on bid evaluation, bid comparison or contract award may result in rejection of the bid.
- 44. Purchaser's Right to Vary Quantities at Time of Award: The Purchaser reserves the right at the time of contract award to increase or decrease the quantity of goods and services originally specified in the schedule of Requirements without any change in unit price or other terms and conditions.
- 45. Purchaser's Right to Accept Any Bid and to reject any or All Bids without assigning any reasons there for.
  - (A). The Purchaser reserves the right to accept or reject any bid, and to annul the bidding process and reject all bids at any time prior to award of contract without there by incurring any liability to the affected Bidder or bidders or any obligation to inform the

affected Bidder or bidders of the grounds for the Purchaser's action.

- (B). Evidence regarding credibility of stable performance and maintenance service capability must be provided. The purchaser reserves the right to makejudgment on this and reject bids that, in the purchaser's view, do not carry sufficient credibility for performance and/or service.
- 46. Bidders, please provide the PAN No., Bank Details, email ID, Contact person details, GST No etc.

#### 47. Warranty:

The supplier warrants that the Goods supplied under this contract are new, unused, of the most recent or current models and those they incorporate all recent improvements in design and materials, unless provided otherwise in the contract. The supplier further warrants that all Goods supplied under this contract shall have no defect arising from manufacturing, design, materials or workmanship (except when the design and /or materials is required by the Purchaser's Specification) or from any act or omission of the supplier, that may develop under normal use of the supplied Goods in the conditions prevailing in the country of final destination.

This warranty shall remain valid (As stated in technical specifications) after the Goods or any portion thereof as the case maybe, have been delivered, installed & commissioned and accepted at the final destination indicated in the contract.

Warranty period shall be (As stated in technical specifications) from date of successful installation of equipment. The Supplier shall, in addition, comply with the performance and/or consumption guarantees specified under the contract. If for reasons attributable to the Supplier, these guarantees are not attained in whole or in part, the Supplier's discretion shall apply making such changes, modifications, and/or additions to the Goods or any part thereof as may be necessary in order to attain the contractual guarantees specified in the contract at supplier own cost and expense and to carry out further performance tests.

If during the period of warranty any component or spare part is needed to be imported, all associated cost for replacement shall be borne by the supplier including the cost of customs duty, customs clearance charges etc.

- 48. COMMENCEMENT OF WARRANTY PERIOD: The warranty period of an item shall commence from the date of receipt of the item in good working condition and satisfactory installation /demonstration at the project site.
- 49. Specifications are basic essence of the product. It must be ensured that the offers must be strictly as per our specifications. At the same time it must be kept in mind that merely copying our specifications in the quotation shall not make the parties eligible for consideration of the quotation. A quotation has to be supported withthe printed technical leaflet / literature of the quoted model of the item by the quoting party/manufacturer.

50. Supplier Integrity: The Supplier is responsible for and obliged to conduct all contracted activities in accordance with the Contract using state of the art methods and economic principles and exercising all means available to achieve the performance specified in the contract.

#### 51. Force Majeure:

The Supplier shall not be liable for forfeiture of its performance security, liquidated damages or termination for default, if and to the extent that, it's delay in performance or other failure to perform its obligations under the Contract is the result of an event of Force Majeure.

For purposes of this Clause, "Force Majeure" means an event beyond the control of Supplier and not involving the Supplier's fault or negligence and not foreseeable. Such eventsmay include, but are not limited to, acts of the Purchaser either in its sovereign or contractual capacity, wars or revolutions, fires, floods, epidemics, quarantine restrictions, act of God and freight embargoes.

#### 52. Termination for Default

- (A). The Purchaser may, without prejudice to any other remedy for breach of contract, by Written notice of default sent to the Supplier, terminate the Contract in whole or part:
  - (i) If the Supplier fails to deliver any or all of the Goods within the period(s) specified in the order, or within any extension thereof granted by the Purchaser.
  - (ii) If the Supplier fails to perform any other obligation(s) under the Contract.
  - (iii) If the Supplier, in the judgment of the Purchaser has engaged in corrupt or fraudulent practices in competing for or in executing the Contract.

#### (B). For the purpose of this Clause:

- (i) "Corrupt practice" means the offering, giving, receiving or soliciting of gratification to influence the action of a public official(s) in the procurement process or in contract execution.
- (ii) "Fraudulent practice" means a misrepresentation of facts in order to influence a procurement process or the execution of a contract to the detriment of the purchase, and includes collusive practice among Bidders (prior to or after bid submission) designed to establish bid prices at artificial non-competitive levels and to deprive the purchaser of the benefits of free and open competition;"

#### 53. Resolution of Disputes:

The Purchaser and the supplier shall make every effort to resolve amicably by direct informal negotiation any disagreement or dispute arising between them under or in connection with the contract.

If, after thirty (30) days from commencement of such informal negotiations, the

Purchaser and the Supplier have been unable to resolve amicably a contractual dispute, either party may require that the dispute be referred for resolution to the formal mechanisms. These mechanisms may include, but are not limited to, conciliation mediated by a third party, adjudication in an agreed national (or) international forum, and national or international arbitration.

In case of Dispute or difference arising between the Purchaser and domestic supplier relating to any matter arising out of or connected with this agreement, such disputes or difference shall be settled in accordance with the Indian Arbitration & Conciliation Act,1996, the rules there under and any statutory modifications or re-enactments thereof shall apply to the arbitration proceedings. The dispute shall be referred to the Director TIFR Hyderabad and if he is unable or unwilling to act, to the sole arbitration of some other person appointed by him willing to act as such Arbitrator. The award of arbitrator so appointed shall be final, conclusive and binding on all parties to this order.

In the case of dispute between the purchaser and Foreign Supplier, the dispute shallbe settled by arbitration in accordance with provision of sub clause above. But if this isnot acceptable to the supplier then the dispute shall be settled in accordance with provisions of UNCITRAL (United Nations Commission on International Trade Law) Arbitration Rules.

54. TIFR Hyderabad reserves the right to ask for or to provide any clarification, changes after the release of this tender. Any changes or clarifications provided by TIFR, Hyderabad may be checked at TIFR Hyderabad website: https://www.tifrh.res.in/index.php/commercial-tenders

ADMINISTRATIVE OFFICER (PURCHASE SECTION) TIFR, HYDERABAD

#### **Annexure - B**

#### **Certificate for Local Content**

\*We [name of manufacturer] hereby confirm in respect of quoted item(s) that Local Content is equal to or more than 50% and come under 'Class-I Local Supplier' Category. As being'Class-I Local Supplier', we are eligible for Purchase Preference under 'Make in India' Policy vide Gol Order No.P-45021/2/2017-PP (B.E.-II) dated 15.06.2017 (subsequently revised vide orders dated 28.05.2018, 29.05.2019 and 04.06.2020)

OR

\*We [name of manufacturer] hereby confirm in respect of quoted items(s) that Local Content is more than 20% but less than 50% and come under 'Class-II Local Supplier' Category.

| The details of the location (s) at which the local val | ue addition made is /are as under: |
|--|------------------------------------|
| 2  |                                    |
| 3  |                                    |
| *Strike out whichever is not applicable                |                                    |
| Date:  | Seal & Signature of the Bidder     |

#### **NOTE:**

- Self-certification that the item offered meets the minimum local content (as above) giving details of the location(s) at which the local value addition is made in case the bidder wishesto avail the benefits under the make in India policy, if applicable.
- In cases of procurement for a value in excess of Rs. 10 crores, the local supplier shall be required to provide a certificate from the statutory auditor or cost auditor of the company(in the case of companies) or from a practicing cost accountant or practicing chartered accountant (in respect of suppliers other than companies) giving the percentage of local content to avail the benefits under the make in India policy, if applicable.

## Annexure - C

## **Audited Annual Turnover**

| S.No. | Financial/<br>Accounting<br>Year | Profit<br>(Currency) | Loss<br>(Currency) | Annual Turnover (Currency) |
|-------|----------------------------------|----------------------|--------------------|----------------------------|
| 1.    |                                  |                      |                    |                            |
| 2.    |                                  |                      |                    |                            |
| 3.    |                                  |                      |                    |                            |

Authorized Signatory with Seal

#### Note:

This Audited Annual Turnover (Annexure – C) for the last 3 years should be certified by Chartered Accountant (CA) as per the format given above duly signed and stamped by the CA on their letterhead.

# <u>Annexure - D</u>

# Supply Order details of High-Performance Computing (HPC) Cluster to other firms.

|        |                                       | Name    | Purchase  | Brief Item                | Item     |
|--------|---------------------------------------|---------|-----------|---------------------------|----------|
| S.No.  | Name of the company with full address | of the  | Order No. | Description<br>with Model | Value in |
|        | auur ess                              | Project | & Date    | No.                       | Currency |
|        |                                       |         |           |                           |          |
|        |                                       |         |           |                           |          |
|        |                                       |         |           |                           |          |
|        |                                       |         |           |                           |          |
| Signat | ure                                   |         |           |                           |          |
| Name   |                                       |         |           |                           |          |
| Design | nation                                |         |           |                           |          |
| Name   | of the Company                        |         |           |                           |          |
| Date   |                                       |         |           |                           |          |
| Seal o | f the Company                         |         |           |                           |          |

NOTE: Please attach the copy documents / purchase order copy for the above mentioned details.

# Financial Bid for Supply, Installation & Commissioning of High-Performance Computing (HPC) Cluster for TIFR Hyderabad (Part - B)

### Annexure - E

| TIFR Hyderabad Enquiry No & Date:                                |
|--|
| Due date:  |
| Bidder's Quotation Ref No. & Date:                               |
| Financial Bid (Bidders must quote their rates using this Format) |

| S.No. | Item Description as per tender   | Make/<br>Brand/<br>Type | Qty.<br>(No) | Rate per<br>unit<br>(Currency) | Basic<br>Cost of<br>main<br>item (In<br>Currency |
|-------|--|-------------------------|--------------|--------------------------------|--|
| A.    | Supply, Installation and Commissioning of<br>a High-Performance Computing (HPC)<br>Cluster for TIFR Hyderabad.<br>(As per Technical Specifications at<br>Annexure - A)           |                         |              |                                | ,  |
| 1     | ,  |                         | 1            |                                |  |
| 1     | Login Node   |                         | 1            |                                |  |
| 2     | Master Node  |                         | 1            |                                |  |
| 3     | Compute Nodes  |                         | 30           |                                |  |
| 4     | Dual controller ZFS compute Storage  |                         | 1            |                                |  |
| 5     | BeeGFS based Parallel File System  |                         |              |                                |  |
| 5.1   | Storage Servers (SS) and MetaData Servers (MGS/MDS) -  |                         | 4            |                                |  |
| 5.2   | Storage for BeeGFS Storage Targets (ST),<br>Meta Data Targets (MDT)  |                         | 1            |                                |  |
| 6     | Network/Interconnect & Connectivity  |                         |              |                                |  |
| 6.1   | Rack mountable 48 Port unmanaged Gigabit switches for IPMI management with required peripheral for rack mounting.  |                         | 1            |                                |  |
| 6.2   | Fully non-blocking 100 G<br>Omnipath/Infiniband/Switchless Torus<br>6D open Ethernet Switch with required<br>cables and network adapter cards for<br>compute nodes connectivity. |                         | 1            |                                |  |
| 7     | KVM Display  |                         | 1            |                                |  |
| 8     | Fully Automated System Provisioning  |                         | 1            |                                |  |

| В. | Ex-Works cost (Duly packed Airworthy/Seaworthy of international standard)  |  |
|----|--|--|
| C. | FOB /FCA Cost (Name of Airport)  |  |
| D. | CIP/CIF Cost (Up to Hyderabad<br>Airport)(all inclusive i.e. Cost of<br>Goods, Packing, Insurance<br>warehouse to warehouse, Inland<br>Transportation, freight etc.) |  |

#### Note:

- 1. All the column should be appropriately filled and not left blank.
- 2. Do not include any other charges, taxes, duties etc. in the Basic Cost of the item. The other charges, taxes, duties etc. to be shown separately.
- 3. Any accessories, optional items should be shown separately using above format.
- 4. Use separate sheet for detail description, specification of the item, Price breakup for the item(s) mentioned in technical specification but prices should be quoted in the same format.
- 5. Prices quoted in Indian Currency for indigenous items should be on F.O.R. basis and mention separately using different table format showing all the applicable taxes/Duties likeGST, Freight & Transportation charges and installation charges etc.

  Use separate sheet for detail description, specification of the item, Price breakup for the item(s) mentioned in technical specification but prices should be quoted in the same format.
- 6. TIFR Hyderabad being educational & research institute, discounted price shall be offered.
- 7. The suppliers/bidders should submit all the applicable list of documents/enclosures/annexures as mentioned in the tender along with the local content certificate filled form as per annexure B. The supplier should provide the local content details / local value addition details with the applicable value. TIFR Hyderabad reserves the right to reject any tender (or) all tenders if not submitted along with the documents/enclosures/annexures/certificate of local content.

|                                      | Signature of the Bidder |
|--------------------------------------|-------------------------|
| Name, Address contact no             |                         |
| & email id of the bidder/            |                         |
| Company with company's Stamp or Seal | Date:                   |

#### Additional Warranty (Optional Item, Quote Compulsory)

| S.No | Item Description                                  | Unit Cost<br>(Currency) | Taxes<br>(%) | Total Cost<br>(Currency) |
|------|---|-------------------------|--------------|--------------------------|
| 1    | 6 <sup>th</sup> year warranty for the Master Node |                         |              |                          |
| 2    | 7 <sup>th</sup> year warranty for the Master Node |                         |              |                          |

| S.No | Item Description                                 | Unit Cost<br>(Currency) | Taxes<br>(%) | Total Cost<br>(Currency) |
|------|--|-------------------------|--------------|--------------------------|
| 1    | 6 <sup>th</sup> year warranty for the Login Node |                         |              |                          |
| 2    | 7 <sup>th</sup> year warranty for the Login Node |                         |              |                          |

| S.No | Item Description  | Unit Cost<br>(Currency) | Taxes<br>(%) | Total Cost<br>(Currency) |
|------|---|-------------------------|--------------|--------------------------|
| 1    | 6 <sup>th</sup> year warranty for the Dual controller ZFS compute Storage |                         |              |                          |
| 2    | 7 <sup>th</sup> year warranty for the Dual controller ZFS compute Storage |                         |              |                          |

| S.No | Item Description   | Unit Cost<br>(Currency) | Taxes<br>(%) | Total Cost<br>(Currency) |
|------|--|-------------------------|--------------|--------------------------|
| 1    | 6 <sup>th</sup> year warranty for the BeeGFS based Parallel<br>File System |                         |              |                          |
| 2    | 7 <sup>th</sup> year warranty for the BeeGFS based Parallel<br>File System |                         |              |                          |

#### Note:

- 1. All the column should be appropriately filled and not left blank.
- 2. Do not include any other charges, taxes, duties etc. in the Basic Cost of the item.
- 3. Any accessories, optional items should be shown separately using above format.
- 4. Use separate sheet for detail description, specification of the item, but prices should be quoted in same format.
- 5. Prices quoted in Indian Currency should be on F.O.R. basis and mentioned separately using different table format showing all the applicable taxes/Duties like GST, Freight & transportation charges and installation charges etc.
- 6. TIFR Hyderabad being educational & research institute, discounted price shall be offered.

Signature of the Bidder

### <u>Annexure - F</u>

#### PERFORMANCE BANK GUARANTEE FORMAT

| (hereinafter called "THE TIFR") having agreed under the terms and conditions of Purchase Order No datedmade between. TIFRand M/s (hereinafter called "the said Contractor{s}"). For the Purchase Order (hereinafter called "the said Purchase Order") having agreed to production of an irrevocable bank Guarantee for Rs. From the contractor(S) for compliance of his obligations in accordance with the terms and conditions in the said Purchase Order, we (indicate the name of the Bank) (hereinafter referred to as "the Bank") hereby undertake to pay to the TIFR an amount not |
|--|
| exceeding Rs.(Rs only) on demand by the TIFR.  |
| 2. We(indicate the name of the Bank) do hereby undertake to pay the amounts due and payable under this guarantee without any demur, merely on a demand from the TIFR stating that the amount claimed is required to meet the recoveries due or likely to be due from the said Contractor(s). Any such demand made on the bank shall be However, our liability under this guarantee shall be restricted to an amount not exceeding Rs(Rupees  |
| 3. We, the said bank, further undertake to pay to the TIFR any money so demanded notwithstanding any dispute or disputes raised by the Contractor(s) in any suit of proceeding pending before any Court or Tribunal relating thereto, our liability under this present being absolute and unequivocal. The payment so made by us under this bond shall be a valid discharge of our liability for payment there under and the Contractor(s) shall have no claim against us for making such payment.   |
| 4. We  |
| 5. We(indicate the name of Bank) further agree with the TIFR that the TIFR   |
| shall have fullest liberty without our consent and without affecting in any manner our obligations hereunder to vary any of the terms and conditions of the said Purchase Order or to extend time of performance by the said Contractor(s) from time to time or to postpone for any time to time any of the powers exercisable by the TIFR against the said Contractor(s) and to forbear or enforce any of the terms and condition s relating to the said Purchase Order and we shall not be relieved from or liability by reason of any such variation, or extension being              |

| whatso                         | any indulgence by the TIFR to the said Contractor(s) or by any such matter or thing ever which under the law relating to sureties would, but for this provision, have effect lieving us. |
|--------------------------------|--|
| _                              | guarantee will not be discharged due to the change in the constitution of the Bank or tractor(s).  |
|                                | e,(Indicate the name of Bank) lastly undertake not to revoke this tee except with the previous consent to the TIFR in writing.   |
| TIFR. N<br>restricte<br>within | This guarantee shall be valid up to unless extended on demand by otwithstanding anything mentioned above, our liability against this guarantee is sed to                                 |
| Signed and                     | i sealed   |
| Dated                          | thefor(indicate  |
| the name o                     | f Bank)  |
|                                |  |

grantedto the said Contractor(s) or for any forbearance, act of mission on the part of the